



ISSCC 2018 Awards

February 12, 2018





ISSCC Awards

2017 Lewis Winner Award for Outstanding Paper

“A 28GHz 32-Element Phased-Array Transceiver IC with Concurrent Dual Polarized Beams and 1.4 Degree Beam-Steering Resolution for 5G Communication”



Bodhisatwa
Sadhu¹



Yahya
Tousi¹



Joakim
Hallin²



Stefan
Sahl³



Scott
Reynolds¹



Örjan
Renström³



Kristoffer
Sjögren²



Olov
Haapalahti³



Nadav
Mazor⁴



Bo
Bokinge³



Gustaf
Weibull²



Håkan
Bengtsson³



Anders
Carlinger³



Eric
Westesson⁵



Jan-Erik
Thillberg³



Leonard
Rexberg³



Mark
Yeck¹



Xiaoxiong
Gu¹



Daniel
Friedman¹



Alberto
Valdes-Garcia¹

¹IBM T. J. Watson Research Center, Yorktown Heights, NY

²Ericsson, Lindholmen, Sweden; ³Ericsson, Kista, Sweden

⁴IBM Research, Haifa, Israel; ⁵Ericsson, Lund, Sweden

The Lewis Winner Award for Outstanding Paper

Lewis Winner served ISSCC for three decades (1958 to 1988) as Editor, Publisher, and Conference Coordinator. He was responsible, in considerable part, for establishing and maintaining the high standards of ISSCC publications and presentations.

The Award in his honour is based on ratings by Conference attendees in the previous year.

2017 Distinguished-Technical-Paper Award

“A 12b 10GS/s Interleaved Pipeline ADC in 28nm CMOS Technology”



Siddharth
Devarajan¹



Larry
Singer¹



Dan
Kelly¹



Jose
Silva¹



Janet
Brunsilius²



Daniel
Rey-Losada²



Frank
Murden³



Jeff
Bray²



Eric
Otte¹



Nevena
Rakuljic²



Phil
Brown³



Todd
Weigandt²



Qicheng
Yu¹



Donald
Paterson¹



Corey
Petersen²



Jeffrey
Geallow¹

with Steve Kasic², Tao Pan¹, Carroll Speir³

¹Analog Devices, Wilmington, MA

²Analog Devices, San Diego, CA

³Analog Devices, Greensboro, NC

The Distinguished-Technical-Paper Award

This Award is based on ITPC ratings at paper selection, as normalized at paper presentation time by ARC.

2017 Jan Van Vessem Award for Outstanding European Paper

“A 1.1W/mm²-Power-Density 82%-Efficiency Fully Integrated 3:1 Switched-Capacitor DC-DC Converter in Baseline 28nm CMOS Using Stage Outphasing and Multiphase Soft-Charging”



Nicolas Butzen



Michiel Steyaert

KU Leuven, Leuven, Belgium

The Jan Van Vessem Award for Outstanding European Paper

Jan Van Vessem served ISSCC as the first Chair of the European Program Committee from 1968 to 1974.
The Award in his honour is based on ratings by Conference attendees in the previous year.

2017 Takuo Sugano Award for Outstanding Far-East Paper

“A Reconfigurable Bidirectional Wireless Power Transceiver with Maximum-Current Charging Mode and 58.6% Battery-to-Battery Efficiency”



Mo Huang^{1,*}



Yan Lu¹



Seng-Pan U^{1,2}



Rui P. Martins^{1,3}

¹University of Macau, Macau, China; ²Synopsys Macau, Macau, China; ³Instituto Superior Tecnico, Universidade de Lisboa, Portugal
*now with South China University of Technology, Guangzhou, China

The Takuo Sugano Award for Outstanding Far-East Paper

Takuo Sugano served ISSCC as an early member of what became the Far-East Program Committee, from 1967 to 1989.
The Award in his honour is based on ratings by Conference attendees in the previous year.

2017 Jack Kilby Award for Outstanding Student Paper

“All-Wireless 64-Channel 0.013mm²/ch Closed-Loop Neurostimulator with Rail-to-Rail DC Offset Removal”



Hossein Kassiri^{1*}



M. Reza
Pazhouhandeh¹



Nima Soltani²



M. Tariqus Salam²



Peter Carlen^{1,3}



Jose Luis Perez
Velazquez¹



Roman Genov¹

¹*University of Toronto, Toronto, Canada; ²GSK (GlaxoSmithKline), Stevenage, United Kingdom

³Toronto Western Hospital, Toronto, Canada

*now at York University, Toronto, Canada

The Jack Kilby Award for Outstanding Student Paper

Jack Kilby, an integrated-circuits pioneer responsible for designing the first monolithic IC, was a long-term ISSCC participant and contributor. The Award in his honour is based on ratings by Conference attendees in the previous year.

2017 ISSCC Award for Outstanding Forum Presenter

"Pushing the Boundaries of Performance – A Technology Perspective"



Marcel Pelgrom

Pelgrom Consult, Helmond, the Netherlands

The Outstanding Forum-Presenter Award

This Award is based on Forum-attendee ratings from the previous year.

2017 ISSCC Award for Outstanding Forum Presenter

"High-Performance Clock Generation and Distribution in Very-High-Speed Wireline Transceivers"



Nicola Da Dalt

Intel, San Jose, CA

The Outstanding Forum-Presenter Award

This Award is based on Forum-attendee ratings from the previous year.

2017 Evening Session Award

"Return of Survey Says!"



Organizer: **Harry Lee**
MIT, Cambridge, MA



Co-Organizer: **Matt Straayer**
Maxim Integrated, North Chelmsford, MA



Moderator: **Chris Mangelsdorf**
Analog Devices, San Diego, CA

Panelists



Robert Adams
Analog Devices, Wilmington, MA



Lucien Breems
NXP Semiconductors,
Eindhoven, The Netherlands



Yun Chiu
University of Texas, Dallas, TX



Michael Choi
Samsung Electronics, Yongin, Korea



Ian Galton
University of California San Diego,
La Jolla, CA



Shanthi Pavan
IIT Madras, Chennai, India



Kathleen Philips
imec/Holst Centre, Eindhoven,
The Netherlands



Ken Poulton
Keysight Labs, Santa Clara, CA

The Evening-Session Award

This Award is based on Conference-attendee ratings from the previous year.

2017 Demonstration Session Certificate of Recognition

“A 1ms High-Speed Vision Chip with 3D Stacked 140GOPS Column-Parallel Processor for Spatio-Temporal Image Processing”



Tomohiro Yamazaki¹

and

Hironobu Katayama¹, Shuji Uehara¹, Atsushi Nose¹, Masatsugu Kobayashi¹, Sayaka Shida¹, Masaki Odahara², Kenichi Takamiya², Yasuaki Hisamatsu², Shizunori Matsumoto², Leo Miyashita³, Yoshihiro Watanabe³, Takashi Izawa¹, Yoshinori Muramatsu¹, Masatoshi Ishikawa³

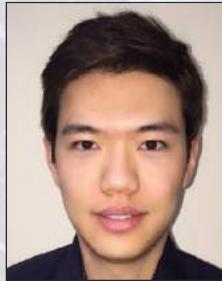
¹Sony Semiconductor Solutions, Atsugi, Japan; ²Sony LSI Design, Atsugi, Japan; ³University of Tokyo, Bunkyo, Japan

Demonstration-Session Award

This Award is based on ratings provided by the Demo-Session Committee from the previous year.

2017 Demonstration Session Certificate of Recognition

“A 0.1-to-3.1GHz 4-Element MIMO Receiver Array Supporting Analog/RF Arbitrary Spatial Filtering”



Linxiao Zhang



Harish Krishnaswamy

Columbia University, New York, NY

Demonstration-Session Award

This Award is based on ratings provided by the Demo-Session Committee from the previous year.



Solid-State Circuits Awards

2016 Journal of Solid-State Circuits Best Paper Award A 2.2 GHz Continuous-Time $\Delta\Sigma$ ADC With -102 dBc THD and 25 MHz Bandwidth



Lucien Breems¹



Muhammed Bolatkale¹



Hans Brekelmans¹



Shagun Bajoria¹



Jan Niehof¹



Robert Rutten¹



Bert Oude-Essink²



Franco Fritschij²



Jagdip Singh²

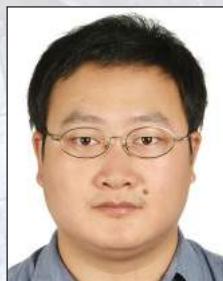


Gerard Lassche²

¹NXP Semiconductors, Eindhoven, The Netherlands

²Catena Microelectronics, Delft, The Netherlands

SSCS Outstanding Chapter Award



Hanjun Jiang
Beijing Chapter

SSCS Beijing Chapter



IEEE

IEEE Technical Field Awards

2018 IEEE Daniel E. Noble Award for Emerging Technologies



Rajiv V. Joshi

IBM T. J. Watson Research Center, Yorktown Heights, NY

"For Contributions to Predictive Failure Analytics, VLSI Memory Design, and Technology"

2018 IEEE Donald O. Pederson Award in Solid-State Circuits (co-recipients)



William S. Carter
Xilinx, San Jose, CA



Stephen M. Trimberger
Xilinx, San Jose, CA

"For Contributions to Field-Programmable Gate Array Technology."

2018 IEEE Frederik Philips Award



Ian A. Young
Intel, Hillsboro, OR

"For Leadership in Research and Development on Circuits and Processes for the Evolution of Microprocessors"



IEEE

2018 Fellows

Pamela Ann Abshire

Silver Spring, MD

*"For Contributions to CMOS Biosensors"***Pietro Andreani**

Lund University, Lund, Sweden

*"For Contributions to CMOS Integrated Voltage-Controlled Oscillators"***Bertan Bakkaloglu**

Arizona State University-Tempe, Scottsdale, AZ

*"For Contributions to Radio Frequency Circuits"***Kun-Yung Chang**

Los Altos Hills, CA

*"For Contributions to Transceivers for High-Performance Networking and High-Density Memories"***Tsung-Yung Chang**

Taiwan Semiconductor Manufacturing Company, Hsinchu, Taiwan

*"For Application of SRAM Technology to Low-Power and High-Performance Computing"***Andreas Demosthenous**

University College London, London, UK

*"For Contributions to Integrated Circuits for Active Medical Devices"***Isaac Lagnado**

San Diego, CA

*"For Leadership in the Development of Silicon-on-Sapphire Technology"***Sanu Mathew**

Intel Corporation, Hillsboro, OR

*"For Leadership in Computer Arithmetic Datapath and Security Circuits"***Earl Mc Cune**

RF Communications Consulting, Santa Clara, CA

*"For Leadership in Polar Modulation Circuits and Signals"***Saibal Mukhopadhyay**

Georgia Institute of Technology, Atlanta, GA

*"For Contributions to Energy-Efficient and Robust Computing Systems Design"***Hidetoshi Onodera**

Kyoto University, Kyoto, Japan

*"For Contributions to Variation-Aware Design and Analysis of Integrated Circuits"***Shanthi Pavan**

Indian Institute of Technology, Chennai, India

*"For Contributions to Delta Sigma Modulators and Analog Filters"***Rahul Sarpeshkar**

Thayer School of Engineering at Dartmouth, Hanover, NH

"For Contributions to Ultra Low-Power Biomedical Electronics"

Note that all ISSCC Awards are scrutinized and vetted by a special group, the Awards and Recognition Committee (ARC) whose current members are:

Kenneth (KC) Smith, Chair (University of Toronto)

Bryan Ackland (Steven Institute of Technology)

Nicky Lu (Etron)

Willy Sansen (K.U. Leuven)

Bruce Wooley (Stanford University)